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SMALL MULTIMODE ANTENNA AND HIGH FREQUENCY MODULE USING IT <u>B</u>

cios is set up at one end of a radiating conductor 1, a quonclos and an RF modulo using such antenna for use in less-costly and small multimedia wireless apparatus is provided. The entenna is configured such that a single feeding point 4 which is common for multiple frequenfirst one-port resonant circuit 2 is connected to the one A small multi-mode antenna in which a single feeding point can be used commonly for multiple fre-(21)

end thereof, and a second one-port resonant circuit 3 is from the feeding point 4 toward free space equaling the characteristic admittance 5 in the RF circuit, a susceptance component of the admittance is canceled out by the resonant circuit 2 connected to the feeding point With a conductance component of admittance in view connected to the other end of the radiating conductor 4 for multiple frequencles.

RESONANT CIRCUIT TIUSRIS

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Description

Technical field

The present invention relates to an antenna of magnetic waves with different frequencies, the Invention relates to a multi-mode antenna applied to the wireless wireless apparatus that provides the user with multi-media services and a RF (Radio Frequency) module Includng the antenna. In particular, for use in multimedia wire less apparatus that Implements a plurality of services by Information transmission through the media of electroapparatus and a mutth-mode compatible RF module including the antenna.

Background Art

ers are required to have different wireless apparatuses formation by way of radio transmission are getting more erms of transferring and providing various kinds of Inactive lately and a great number of wireless apparatuses services are diversified year after year, involving telephones, TVs, Local Area Networks (LANs), etc. End ushave been developed and put into practical use. These providing services different services to receive all services. services

With the aim of Improving the usability of end anywhere, namely, in a ubiquitous manner, thus making users who receive such services, attempts have already started to provide the services to end users anytime and the presence of media transparent to the users. A shigle terminal apparatus that Implements a plurailty of Infornation transfer services, namely, a so-called multimode terminal is realized, but partially.

service. Therefore, a multi-media terminal is required to [0004] Because a ubiquitous information transmission service by ordinary radio transmission uses elecromagnetic waves as its medium, a plurality of services are provided to end users by using several frequencies n a same service area; one frequency for one type of have capability of transmitting and receiving multiple fre-

method in which a plurallly of single-mode antennas, each provided for one frequency, are installed on a sintance equivalent to wavelength to make each singlemode antenna operate Independently. Because the frequencies of electromagnetic waves that are used for nission are limited to a range from a few hundred MHz to a few GHz due to the limitation of their free space rated each other by a distance of a few tens of centimsters to a few meters. Consequently, the dimension of s not satisfied. Because the antennas sensitive to difgie wireless apparatus is used. In this method, it is need ed to install the entennes separated each other by a disservices in terms of normal ubiquitous information trans propagation characteristic, the antennas must be sepa the terminal becomes targe and portability for the use muttmedia conventional ē

by a distance, it is needed to install separate RF ctrcuits connecting to the antennas for each frequency.

dimensions allowing for portability for the user is around formation services or a significant increase in the termi-nal weight due to increased battery volume and poses 0006) For this reason, it is difficult to apply semiconductor integration circuit technology and there arises a problem of high-cost RF circuits as well as the increased dimensions of the terminal. Even when the RF circuits are integrated into a whole by applying the integration circuit technology with great efforts, there is a need for connecting the RF circuit to the individual antennas separeted by a distance with RF cables. By the way, the diameter of the RF cable applicable to a terminal with one millimeter. Consequently, transmission loss of the RF cable in the current situation reaches a few dB/m With the use of such RF cable, power consumed by the RF circuit increases. This causes a significant decrease In use duration of the terminal providing ubiquitous ina problem of significantly degrading the usability for the user of the terminal.

which transmits at one frequency and the other end is [0007] Aside from the foregoing, two-frequency duplex antennas in which one end of a loop antenna or the material of the antennal is connected to a transmitter connected to a receiver which receives at the other frequency are disclosed (e.g., Japanese Patent Laid-Open No. S61(1986)-295905 and Japanese Patent Laid-Open No. H1(1989)-158805).

[0008] A two-frequency duplex enterns described in Japanese Patent Laid-Open No. S81(1986)-295905 is configured such that first and second resonant circuits respectively connected to either ends of the loop antenna which is a radiating conductor resonate with the loop nates at a transmit frequency and the other resonator at the other terminal resonates at a receive frequency, and the transmitter is connected to the one terminal and the antenna, wherein one resonator at one terminal reso receiver is connected to the other terminal.

Another two-frequency duplex antenna de-158805 is configured such that a first resonant circuil lion conductor and a transmit output terminal, assumes scribed in Japanese Patent Laid-Open No. H1(1989) resonating at a transmit frequency, connected betweer one end of the matertal of the antenna which is a radia terminal of the material of the antenna and a receive in put terminal, assumes a high impedance to a transmi a high impedance to a receive frequency and discon nects the material of the antenna from the transmit out the receiving frequency, connected between the othe requency and disconnects the material of the antenni put terminal, and a second resonant circuit resonatin

of these two-frequency duplex antennas, it is needed to provide the transmitter and the receiver for each of input and output terminals (feeding points) forested as annual Even for a wireless apparatus employing either

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ate positions for different frequencies. Thus, it is difficult to integrate both, which makes a bottleneck in downsizng the wireless apparatus.

### Disclosure of Invention

impedance in free space and the characteristic impedance in the RF circuit of the wireless apparatus for elecmagnetic waves with multiple frequencies. The multimode antenna is a single structure that realizes a supe-[0011] One of key devices of a multimedia wireless rior matching characteristic between the characteristic apparatus is a mulii-mode antenna sensitive to electrotromagnetic waves with multiple frequencies.

[0012] If, in such multi-mode antenna, a same feeding tor integration circuit technology can be applied and, therefore, RF circuit downsizing can be achieved and a point (input-output terminal) can be set up for electromagnetic waves with different frequencies, RF circuits the single feeding point. In consequence, semiconducsmall and less costly RF module compatible with multithat process multiple frequencies are allowed to share ple frequencies can be realized.

a small multi-mode antenna in which a single feeding point can be used commonly for multiple frequencies in order to realize a less costly and small multimedia wireless apparatus, and to provide a small RF module using [0013] Objects of the present invention are to provide the multi-mode antenna.

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2 resonant circuit connected to one end of the radialing [0014] To achieve the above objects, a multi-mode gie feeding point which is common for the plurality of frequencies and connected to the first one-port resonant netic waves with a plurality of frequencies for which the entenna should operate, a first one-port (two-terminal) conductor, a second one-port resonant circuit connected to the other end of the radiating conductor, and a sinentenns of the present invention has a structure comprising a radisting conductor which radiates electromag-

a plurality of input-output terminals (feeding points), fiput terminal) for a plurality of different frequencles, a plurality of RF circuits that process multiple frequencies can be integrated and downstzing and cost reduction of the plurailly of RF circuits are realized, and, moreover, the entenna itself can be made smaller because of including the single feeding point only. In the case of prior art antennas, to ensure electrically independent operations of nite space is required between the terminats and provision of such space has been a bottleneck in downsizing In the multi-mode antenna having such structure, because there is the same feeding point (input-out-[0015]

2 tion is owing to the invention of a new resonant circuit design technique different from the prior art. Resonant The reason why the single feeding point could be set up for multiple frequencies in the present invencircuits included in the multi-mode antenna of the [0016]

sumes an impedance matching with the impedance in the RF circuit for multiple frequencies, and matching beductor and a plurality of resonant circuits connected to the single feeding point of the multi-mode antenna astween the characteristic impedance in free space and the characteristic impedance in the RF circuit is atpresent invention do not perform action which has been applied in prior art, i.e., a resonant circuit is opened or short-circuited for a certain frequency and electrically disconnects a part of the radiating conductor from the other part. Instead, in this invention, the radiating conit operate in unison. In consequence, taken as a whole,

ing conductor is regarded as a distributed resonant cirresonant circuits shown in these figures and the radiat-Designing the resonant circuits according to the present invention is performed such that the radiatcult comprising a capacitance component with a resistance component and an inductance component. According to the design method of the present invention. for example, for the structures shown in FIG. 11A, 11B, and 11C, subject to the values of the elements of the ing conductor dimensions, with regard to two-mode operation for 1 GHz and 2 GHz, good impedance matching equal to or less than a standing wave ratio of 2 (VSWR c 2) is ensured over bandwidths of 3% and 5.5% respeclively for the above frequencies and bands. [0017]

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### Brief Description of Drawings

### [0018]

FIG. 1 is a structural diagram to explain one embodlment of a multi-mode antenna of the present inven-

of resonant circuits of the multi-mode antenna; FIG. 3 is a curve graph chart to explain a reactance FIG. 2 is a Smith chart to explain the characteristics function of the resonant circuits of the multi-mode FIG. 4 is a structural diagram to explain another mutti-mode antenna embodiment of the present in-

multi-mode antenna embodiment of the present in-=1G. 5 is a structural diagram to explain another

multi-mode antenna embodiment of the present in-FIG. 6 is a structural diagram to explain anothe

multi-mode antenna embodiment of the present in-FIG. 7 is a structural diagram to explain another

FIG. 8 is a structural diagram to explain another mutti-mode antenna embodiment of the present in-

multi-mode antenna embodiment of the present invention; rig. 9 is a structural diagram to explain another

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FIGS. 10A1, 10A2, 10B1, and 10B2 are circuit schematics to explain the resonant circuits for use in the multi-mode antenna of the present invention; multi-mode antenna embodiment of the present in-FIG. 11A is a perspective view to explain another

FIGS, 11B and 11C are circuit schematics to explain the resonant ctrcuits employed in the embodiment

FIG. 12A is a perspective view to explain another shown in FIG. 11A;

FIGS. 12B and 12C are circuit schematics to exmulti-mode entenna embodiment of the present in-

plain the resonant circuits employed in the embod-FIG. 13 is a perspective view to explain anothermulthmode antenna embodiment of the present invenment shown in FIG. 12A;

mult-mode antenna embodiment of the present in-FIG. 14 is a perspective view to explain another

FIG. 15 is a perspective view to explain another

FIG. 16 is a development view to explain anothermulti-mode antenna embodiment of the present mutil-mode antenna embodiment of the present in-

thermuti-mode antenna embodiment of the present FIG. 17 is a development view to explain ano-

FIG. 18 is a development view to explain anohemulii-mode antenna embodiment of the present

multi-mode antenna embodiment of the present in-FIG. 19 is a development view to explain another

multi-mode antenna embodiment of the present In-FIG. 20 is a development view to explain another

FIG. 21 is a development view to explain another multi-mode antenna embodiment of the present in-

FIG. 22B is a bottom view of the RF module shown FIG. 22A is a top view to explain an embodiment of an RF module of the present invention;

FIG. 23A is a top view to explain another RF module

FIG. 23B is a bottom view of the RF module shown embodiment of the present invention; h FIG. 23A.

FIG. 24A is a top view to explain another RF module 71G. 24B is a bottom view of the RF module shown embodiment of the present invention; and

Best Mode for Carrying Out the Invention

[0019] The multi-mode antenna and the RF module

using it in accordance with the present invention will be described hereinafter more fully with reference to sevaral embodiments shown in the drawings, in the drawings, functionally identical components are assigned the same reference numbers and their explanation is not re-

tenns embodiment of the present invention and their lively, to explain the characteristics of resonant circuits 0020) One embodiment of the present invention is described with FIGS. 1, 2, and 3. FIG. 1 is a structural diagram showing the components of a multi-mode anconnections. FIG. 2 and FIG. 3 are a Smith chart and a reactance function characteristic graph chart, respec-

onent circuit 2 are connected functions as a shigle feed-ing point 4. To the feeding point 4, an RF circuit repre-sented as a series equivalent circuit consisting of a chara first one-port resonant circuit 2 is connected between one end of a radiating conductor 1 which radiates elec-[0021] In FIG. 1, the antenna has a structure in which tromagnetic waves with mutilple frequencies and a ground potential point, a second one-port resonant dring conductor 1 and a ground potential point, and a point at which the radiating conductor 1 and the one-port rescuit 3 is connected between the other end of the radialacteristic impedence 5 and a voltage source 6 is con-8 R

compatible with four frequencies can be realized by adopting either of the circuits of FIGS. 1081 and 108. as equivalent circuits, using reactance elements. That is, an equivalent circuit is formed by a resonant circuit ductance) element. Examples hereof are shown in FIGS. 10A1, 10A2, 10B1, and 10B2. As will be defrequencies can be realized by adopting either of the circuits of FIGS, 10A1 and 10A2 and a four-mode antenna and 1082 are equivalent circuit representations of resfor the number of frequencies that are supported by the [0022] The resonant circuits 2 and 3 are represented consisting of a C (capacitance) element and an L (inscribed later, a two-mode antenna compatible with two The circuit examples of the FIGS. 10A1, 10A2, 10B1, onant circuits formed of a minimum number of elements 2 \$ 8

mittance equivalent to the characteristic impedance 5 in the RF circuit and a specific imaginary part value and value having an absolute value approximately equaling sign. The admittance with the susceptance value is set circuit 2 is connected in parallel with the RF circuit at the the radiating conductor 1 and the second resonant circult 3 are set to assume an admittance having a real part value approximately equaling a characteristic edthe first resonant circuit 2 is set to have a susceptance the specific imaginary part value, but with an inverse near a point A or B in FIG. 2, because the first resonant [0023] At the feeding point 4, for multiple frequencies \$ 8

[8824] A circle on which the points A and B exist in FIG. 2 corresponds to the locus of the characteristic adleeding point 4.

nitiance represented as a pure resistance component oquivalent to the characteristic impedance, when the Smith chart is normalized by the characteristic imped-

ance 5 in the RF circuit.

[1023] Thus, when the points A and B exist on the locus of the characteristic admittance, a good matching between the RF circuit and the multi-mode entinane of the present invention can be achieved. Viewing from another perspective, in order to achieve the good matching state between the RF circuit and the multi-mode antennot of the present invention, it is required that the admittance with the susseptiance value be present near the locus of the characteristic admittance.

10036] To make the antienna of this embodiment oporate as the multi-mode antenna compatible with multiple carriers, for the frequencies of the carriers, it is requeed that the admittances he view from the feeding point
4 toward the radialing conductor 1 be present near the
point A or B in Fig. 2 and it is destrable that the admittience be present near the point A or B alternately betwoon A and B or B and A in the frequency increase
the point A represents a point in one semicircular portion
where the susceptience value is positive of the charactends is admittance becaus and the point B represents a
point in the other semidicular portion where the suscaptience value is negative. The reason hereof is de-

scribed with F1G. 3.

[10037] In the equivalent circuit representation of the first resonant circuit 2, according to plecement of the C-copocitance) and L (inductance) elements, the frequency characteristic of the susceptance of the first resonant circuit takes any form of the following: F and Gi. F. G., and H; GI and H; and GI only (le1,2,...). The frequency characteristic of the susceptance value (IB) of the first resonant circuit 2 appears in a monotonically increase along the frequency state, as shown in F1G. 3. This fact has aboven in F1G. 3. This fact has aboven from a relationship between a resonance bunction row a resonance hundlen or susceptance hundlen and a Hurwitz eigence bunction and a Hurwitz

coptable As will be appreciated from FIG. 3, the suscaptiance function alternative between pole and sore or
sore and pole, as the frequency increases. The number
of poles and zeros has on-clo-one correspondence to
the number of the C and L elements in the equivalent
circuit representation of the resonant circuit and one L-C
part generates one pole or zero. That is, the circuit of FIG. 10A1 generates one pole and the circuit of FIG.
10A2 generates one zero. One alternation occurs
across the circuits of the FIGS. 10A1 and 10A2 and the
combination of these dirails is compatible with two frequencies. Three ellemetions occur across the circuits
of FIGS. 10B1 and 10B2 and oach circuit is compatible
with two frequencies.

[0029] For the froquencies of multiple carriers that the antenna of this embodiment should transmit and receive as the multi-mode entenna, when the admittance in view

from the feeding point 4 toward the radiating conductor.

It assumes vatues elementaring between the points A and

B. the first resonant circuit 2 that cancels out the susexplance component of the admittance at these points

A and B can be configured in the equivalent circuit representation with a minimum number of elements. In this

case, the sum of the number of poles and the number
of zeros in the equivalent circuit representation of the

first resonant circuit 2 will be equal to the number of poles

multiple frequencies. In this way, the first resonant circuit

can be designed to be smaller with lower loss and, consequently, the entienne can be downsized. Moreover, as
is apparent from FIG. 3, abrupt impedence change in

relation to an unwentled pole for the carriers with adja
cent frequencies can be avoided and this produces an

effect that the enterna taken as a whole has a broader

[0030] Thus, the present invention realizes good impedance matching between the RF dircuit and free paces at the single feeding point 4 and the energy of the electromagnetic waves with multiple frequencies coming to the antenna of the present invention can be conducted to the RF circuit efficiently. The effect hereof is realizing a suitable multi-mode entenna for multimedia wireless parturus that provides the user with a plurality of whethers information transmission services, using the carriers with different frequencies.

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19031] Another embodiment of the present invention is described with FIGS. 4, 2, and 3, FIG. 4 is a structural degram abrowing the components of another multi-mode antenna embodiment of the present invention and their connections. Difference from the embodiment of FIG. 1 lies in the first one-port resonant circuit 2, one end of which not connecting to the radiality conductor difference from the radiality conductor and seatons to a ground potential point. 4 without the ornection to a ground potential point, in this embodiment also, for the resonant circuits 2 and 3, the circuits shown in, e.g., FIGS. 10A1, 10A2, 10B1, and 10B2 are em-

10032] At a connection point 140 between the first one-port resonant circuit 2 and the radiating conductor 1, for multiple frequencies, the radiating conductor 1 and the second resonant circuit 3 assume an impedance hawing a real part value approximately equaling the characteristic impedance 5 in the RF circuit and a specific imaginary part value and the first resonant circuit 2 thas a reactence value hawing an absolute value approximately equaling the specific imaginary part value, but with an inverse sign.

10033] The impedance with the reactance value is set mear a point a or b h FIG. 2, because the first resonant featult 2 is connected in series with the PoTh's carried at the feading point 4. A circuit on which the polins a and b wats in FIG. 2 corresponds to the locus of the characteristic impedance represented as a pure resistance component equivalent to the characteristic impedance, when the Smith chart is normalized by the characteristic impedance in the RF circuit.

[0034] Thus, when the points a and b exist on the locurs of the characteristic myedance, a goodmatching between the RF circuit and the multi-mode antenna of the present invention can be exhleved. Viewing from another perspective, in order to schleved. Viewing from another perspective, in order to schleved the good matching state between the RF circuit and the multi-mode antenance of the present invention, it is required that the impedance ance with the reactance value be present near the locus of the characteristic impedance.

reate as the multi-mode anterna of this embodiment operate as the multi-mode anterna compatible with multi-mode anterna compatible with multi-quired that the impedance by view from the connection point 140 toward the radiating conductor 1 be present near the point a or b in FIG. 2 and it is desirable that the impedance be present near the point a or b attendable between a end b or a end b in the frequency increase direction from one carrier frequency to another. Here, the point a represents a point in one semicircular portion where the reactance value is positive of the characteristic includence locus and the point be operated as point in the other semicircular portion where the reactance value is negative. The reason and effect hereof are the same as stated for the embodiment of FIG. 1. The sum of the number of poles and the number of zeros in the equivalent circuit representation of the first resonant circuit valid be equal to the number of number of the number of number of the number of number of

[0036] The effect of this embodiment is the same as the embodiment of Fig. 1 and, moreover, this embodiment of Fig. 1 and, moreover, this embodiment of Fig. 1 and moreover, this embodiment of the resonant circuit 2 can be realized by an equivalent drout with a smaller range of the values of the elements, when the imaginary part of the impedence that the realisting conductor 1 and the second resonant circuit 3 assume at the connection point 140 has a great absolute value.

[0037] Another embodiment of the present invention is described with FIG. 5. FIG. 5 is a structural diagram shrowing the components of another multi-mode anterna embodiment of the present invention and their connections. Difference from the embodiment of FIG. 2 lies in that a third one-port resonant circuit 7 is inserted between the connection point 140 and a ground terminal

to the second of the accordinate of the accordinate of the according to, e.g., the equivalent circuit according to, e.g., the equivalent circuit configurations of FIGS. 1081 and to the according to, e.g., the equivalent circuit according to, e.g., the equivalent circuit according to, e.g., the equivalent circuit configurations of FIGS. 1081 and 10A2. The sum of the number of poles and the number of zeros in the equivalent circuit acpressibility of the first one-port resonant circuit 2 and the third one-port resonant circuit 3 and the cornection point 140 will be equal to the number of multiple frequencies to be supported by the entienna.

ment has an effect that the third resonant circuit 7 can be realized by an equivalent circuit with a smaller range of the values of the elements, when the Insaginary part of the impedance that the radiating conductor 1 and the ascend resonant circuit 3 assume at the connection point 140 has an absolute value that changes, or increases or decreases, depending on the above multiple

[0040] Another embodiment of the present invention is described with FiG. 6, FiG. 6 is a structural diagram showing the components of another multi-mode antern an embodiment of the present invention and their connections. Difference from the embodiment of FiG. 5 lies in that the second one-port resonant drout 3 is formed in that the second one-port resonant drout 3 is formed and, and a ground potential point. Again, his embodiment as point along the radialing conductor 1, not 1is end, and a ground potential point. Again, his embodiment also, a bournade anienne can be realized by reselizing the second resonant drout 3 according to, e. 9. the equivalent drout 7 according to, e. 9. the equivalent drout 7 according to, e. 9., the equivalent drout configurations of FiGS. 1041 and 10A2.

[0041] The effect of this embodiment is the same as the embodiment of FIG.5 and, moreover, this embodiment of FIG.5 and, moreover, this embodiment and the the despetate but the redaing conductor 1 and the second resonant circuit 3 sesume at the connection point 140 is restricted from changing, depending on the multiple frequencies to be surported by the anothema, and the first and third resonant circuits 2 and 7 can be realized by an equivalent circuits 2 and 7 can be realized by an equivalent circuit 2 and 7 can be realized by an equivalent circuit 2 and 7 can be realized by an equivalent circuit 2 and 7 can be realized by an equivalent circuit 2 and 7 can be realized by an equivalent circuit with a smaller range of the values of the elements.

19042] Another embodiment of the present invention is described with FIG. 7. FIG. 7 is a structural diagram as showing the components of another multi-mode aniterna embodiment of the present invention and their connections. Difference from the embodiment of FIG. 5 lies in that a fourth one-port resconent circuit 8 is formed between one point and another point along the resonating conductor 1. In this embodiment, a fourth-mode enfertual occupant of the second circuits 2, 3, 7, and 8 according to, e.g., the equivalent circuits configurations of FIGS. 1041 and 10A2.

(1043) The effect of this embodiment is the same as the embodiment of FiG. 5 and, as is the case for the embodiment of FiG. 6, this embodiment has effects that the absolute value for the imaginary part of the timped-ance has beabular value for the imaginary part of the timped-ance that the radiating conductor 1 and the second resonant circuit 3 easume at the connection point 140 is so restricted from changing, depending on the multiple frequencies to be supported by the antenna, and the first and third resonant circuits 2 and 7 can be realized by an equivalent circuit stands of the velues

1904.] Another embodiment of the present invention is described with FIG. 8 is a structural diagram showing the components of enother multi-mode antier as embodiment of the present invention and their con-

he embodiment of FIG. 1 and, moreover, this embodi-

the antenna, and the first and third resonant circuits 2 and 7 can be realized by an equivalent circuit with a ductor 1 and the second resonant circuit 3 assume at the embodiment of FIG. 7 and, even when the physical size of the radiating conductor 1 is small and it is hard to form two points between which the fourth resonant ductor, as is the case for the embodiment of FIG. 7, this embodiment has effects that the absolute value for the imaginary part of the impedance that the radiating conthe connection point 140 is restricted from changing, depending on the multiple frequencies to be supported by (0045) The effect of this embodiment is the same as circuit 8 should be connected along the radiating consmaller range of the values of the elements.

the other end of the radiation conductor 9 and a ground potential point. In this embodiment, a four-mode anienna can be resilized by resilizing the first to fourth resonant In that one end of the second one-port resonant circuit 3, the end not connecting to the radiation conductor 1, tached to one end of a second radiating conductor 9 and a fourth one-port resonant circuit 8 is formed between 10046] Another embodiment of the present invention is described with FIG. 9. FIG. 9 is a structural diagram Is disconnected from the ground potential point and atcircuits 2, 3, 7, and 8 according to, e.g., the equivalent showing the components of another multi-mode antenns embodiment of the present invention and their connections. Difference from the embodiment of FIG. 5 lies circuit configurations of FIGS, 10A1 and 10A2.

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redisting conductor of the antenna of the present invenresonant circuit 3 assume at the connection point 140 is restricted from changing, depending on the multiple frequencies to be supported by the antenna, and the first of the elements. Although an instance where the radial-[0047] According to this embodiment, even when there is spatial limitation that makes it hard to form the tion as a single continuous structure, as is the case for the embodiment of FIG. 7, this embodiment has effects pedance that the radiating conductor 1 and the second and third resonant circuits 2 and 7 can be realized by ing conductor is divided into two continuo bodies is presented in this embodiment, dividing it into two bodies is not always required and it is possible to divide it into three or more continuous bodies; even in this case, an lly be realized by analogy with the embodiments of this that the absolute value for the Imaginary part of the imen equivalent circuit with a smaller range of the values antenna configuration having the same effects can easfigure and FIGS. 7 and 8.

Another embodiment of the present invention

above a ground substrate 11 with a gap of 3 mm from the ground substrate 11. Both ends of the rectangular plate portion are bent vertically toward the ground submately 3 mm and keeping a width of 1 mm in order not to bring the plate portion in electrical contact with the FIG. 1. The radiating conductor 1 is formed by bending a 1 mm wide strip conductor and its rectangular plate portion which is 1 mm wide and 15 mm long is placed strate 11 to form extensions with a length of approxias an example the configuration of the embodiment of Is described with FIGS. 11A through 11C. FIG. 11A shows a design example of a small multi-mode antenna embodiment of the present invention; this design takes

the bent ends and the ground substrate and the second end of the conductor 1 and the ground substrate. The feeding point 4 is set up at the connection point at which are connected, also connecting to the RF circuit represented as the equivalent circuit consisting of the char-The first one-port resonant circuit 2 is formed between one end of the strip radiating conductor 1 with ons-port resonant circuit 3 is formed between the other the radiating conductor 1 and the first resonant circuit 2 acteristic impedance 5 and the voltage source 6. [0049]

able to get benowldthe of 3% and 5% satisfying that Ver-tical Standing Wave Ratio (VSWR) < 2, respectively, for carrier frequencies of 1 GHz and 2 GHz and to realize [0050] In this structure, by configuring the first resonant circuit 2 as an equivalent circuit that assumes sus-FIG. 11B and configuring the second resonant circuit 3 as an equivalent circuit that assume reactance [X (Co  $\approx$ ceptance jBs (Cs = 21.5pF, Ls = 0.169 nH) shown in 0.0827 pF, Lo = 24.60 nH) shown in FIG. 11C, it was a two-mode antenna.

the embodinent of FIG. 11, wherein the radiating con-ductor structure is coupled to the resonant circuits. In this structure, by configuring the first resonant circuit 2 as an equivalent circuit that assumes susceptance [Bs Standing Wave Ratio (VSWR) < 2, respectively, for car-rier frequencies of 1 GHz and 2 GHz and to resitze a sign takes as an example the same configuration as in Lo = 24.06 nH) shown in FIG. 12C, it was able to get bandwidths of 0.7% and 10% satisfying that Vertical [0051] Another embodiment of the present invention is described with FIGS. 12A through 12C. FIG. 12A shows another design exemple of a small multi-mode (Cs = 32.1pF, Ls = 0.593 nH) shown in FIG. 12B and configuring the second resonant circuit 3 as an equivalent circuit that assume reactance JX (Co = 0.0885 pF, two-mode antenna in which a significant difference lies between the bandwidths to be supported by the antenna antenna embodiment of the present invention; this defor the above two carrier frequencies. \$ 8

showing the components of a small multi-mode antenna embodiment of the present invention and their connec-tions. Difference from the foregoing embodiments lies [0052] Another embodiment of the present invention is described with FIG. 13. FIG. 13 is a structural diagram

the series connection of the characteristic impedance 5 and the voltage source 6 is represented as a single exn that the radiating conductor 1 incorporates ground poential integral with it in structure. In this embodiment, citer 12 for clarity of the drawing.

[0053] Because the plate-like radiating conductor 1 ncorporates ground potential integral with it in this embodiment, one end of the first one-port resonant circuit 2 is coupled to one end of the exciter 12 at the feeding point 4, both ends of the series connection of the first nected to the radiating conductor 1 in a first gap 13, and both ends of the second one-port resonant chcult 3 are electrically connected to the radiating conductor 1 in a resonant circuit 2 and the exciter 12 are electrically consecond gap 14.

cause the antenns itself incorporates ground potential integral with it, this embodiment has the following effects: this entenna is allowed to operate independently RF circuit and its design can easily be made without tak-ing the influence of this circuit board into consideration; moreover, an entenna meets specifications requiring that the radiating conductor and the RC circuit be The equivalent circuit in this embodiment structure is equivalent to the embodiment of FIG. 4 and this embodiment can provide the same effect as the embodiment of FIG. 4. In this embodiment structure, beof a circuit board that provides ground potential to the prounded separately is realized.

that the radiating conductor 1 has a third gap 15 and the third one-port resonant circuit 7 is electrically connected 10055] Another embodiment of the present invention is described with FIG. 14. FIG. 14 is a structural diagram showing the components of a small multi-mode antenna embodiment of the present invention and their conneclions. Difference from the embodiment of FIG. 13 lies in to the redisting conductor 1 in the third gap 15.

ture has the following effects: it enables simple design without taking the influence of the RF circuit board into cations requiring that the radiating conductor and the as the embodiment of FIG. 5 or FIG. 6. As Is the case for the embodiment of FIG. 13, this embodiment struc-(0056) The equivalent circuit in this embodiment structure is equivalent to the embodiment of FIG. 5 or FIG. 6 and this embodiment can provide the same effect consideration and realizes an antenna meeting specifi RC circuit be grounded separately.

embodiment of the present invention and their conneclions. Difference from the embodiment of FIG. 14 lies in (9957) Another embodiment of the present invention is described with FIG. 15. FIG. 15 is a structural diagram showing the components of a small multi-mode antenna that the first gap is integral with a sift 16 which is formed

current near the exciter can be controlled by shaping the [0058] According to this embodiment, because the radiating conductor 1 with the slit 16, Impedance change with frequency change at both ends of the series con-nection circuit of the first resonant circuit 2 and the ex-

be expanded. Although the sit 16 is not closed in the conductor in this embodiment, it can easily be reasoned bandwidths for different multiple carrier frequencies can by analogy that an enclosed, so-called slot shape can

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yield the same effect.

the entenna structure is made up of a top layer 21 which forms the top surface, a left side surface 22, a right side surface 23, a front surface 24, an inflammediate layer 25 is described with FIG. 16. FIG. 16 is a diagram showing vention is embodied, formed by employing a multilayer substrate, in relation to its fabrication method, wherein between layers, and a bottom layer 26 which forms the a small multi-mode antenna structure in which the in-[0059] Another embodiment of the present invention

tom surface of the upper dielectric substrate 28, a lower dielectric substrate 27 in contact with the intermediate layer 25, and a bottom layer pattern for the bottom layer. strate 27 consisting of a dielectric are formed. The intermediate layer 25 may be formed on the top surface 26 under the bottom surface of the lower dielectric suba top tayer pattern for the top layer 21, an upper dielectric substrate 28 consisting of a dielectric, on the top surface of which the top layer 21 is placed, an intermediate layer pattern for the intermediate layer 25 under the bot-[0060] To form this structure, by a multilayer process

a radiating conductor right aide pattern 33 is printed by thick film or thin film process. On the intermediate layer 25 under the bottom surface of the upper defecting substrate 28 (or on the top surface of the lower defecting. strate 28 by a thick film process or thin film process. On a left side surface 22 portion of the upper dielectric substrate 28, a radiating conductor left side pattern 32 is printed by thick film or thin film process. On a right side a second strip ground conductor pattern 52 which form second spiral conductor pattern 42 which form the interby thick film or thin film process. On the bottom layer 26 under the bottom surface of the lower dielectric substrate 27, a first strip ground conductor pattern 51 and the bottom layer pattern are printed by thick film or thin of the lower dielectric substrate 27, [1061] A radiating conductor top layer pattern 31 which forms the top layer pattern for the top layer 21 is printed on the top surface of the upper dielectric subsurface 23 portion of the upper dielectric substrate 28, substrate 27), a first spiral conductor pattern 41 and a mediate layer pattern are printed by thin film process. On a left side surface 22 portion of the lower dielectric substrate 27, a feeding conductor pattern 34 is printed 9 8

bottom surface of the upper dielectric substrate 28 and the top surface of the lower dielectric substrate 27 are bonded together and the multilayer structure is complet-ed. For bonding, for example, the following method is 10062] After these patterns are printed as above, the used; form a bonding layer on the bottom surface of the substrate 28 or the top surface of the substrate 27, place

make the permittivity of the upper dielectric substrate 28 dor to docrease the coupling between the radiating conductor patterns 41, 42 and increase the efficiency of radiation of electromagnetic waves from the radiating conductor patterns However, when they are different, it is preferable to [0064] In the structure of this embodiment, permittivity dielectric substrate 27 may be identical or different. lower than that of the lower diefectric substrate 27 in orof the upper dielectric substrate 28 and that of the lower 31, 32, 33 to free space.

etrate 27.

(0065) Moreover, in this embodiment, it is possible to or magnetic substrates made of a magnetic substance. magnotic substrate lower than that of the lower magnetroplace the upper delectric substrate 28 and the lower dielectric substrate 27, respectively, with upper and lowstrate and that of the lower magnetic substrate may be identical or different. However, when they are different, in that event, permeability of the uppor magnetic subit is preferable to make the permeability of the upper ic substrate.

to the ground potential of the RF circuit, the structure of [0066] In this embodiment structure, the equivalent be realized with the spiral conductors 41, 42 and the Ing the first and second strip ground conductors 51, 52 circuit representations of resonant circuit structures can through holes 44. By setting up the feeding point anywhere in the feeding conductor pattern 34 and connectthe embodiment of the FIG. 1 can be realized.

[0087] Therefore, according to this embodiment, the multi-mode antenna in which the invention is embodied quently, downsizing the multi-mode antenna and cost can be fabricated by way of multilayor process; consereduction by manufacturing aconomy of scale are

Another embodiment of the present invention is described with FIG. 17. FIG. 17 is a diagram showing a small multi-mode antenna structure in which the in-

ars, a second intermediate tayer 25b between layers, a bottom tayer 26 which forms the bottom surface, and a vention is embodied in relation to its mutiliayer substrate up of a top layer 21 which forms the top surface a left side surface 22, a right side surface 23, a front surface 24, a first intermediate layer 25a between lay-

under the bottom surface of the upper dielectric substrate 29, an intermediate dielectric substrate 29 in conlectric substrate 29, the lower dielectric substrate 27 in bottom layer pattern for the bottom layer 26 under the on the top surface of the intermediate dielectric substrate 29 and the second intermediate layer 25b may be rear surface 30. [0069] To form this structure, by multilayer process, lectric substrate 28 consisting of a dielectric, on the top mediate layer pattem for the first intermediate layer 25s tact with the first intermediate layer 25a, a second intercontact with the second intermediate layer 25b, and the bottom surface of the lower diefectric substrate 27 are formed. The first intermediate layer 25a may be formed formed on the top surface of the lower dielectric subthe top layer pattern for the top layer 21, the upper diesurface of which the top layer 21 is placed, a first intermediate layer pattern for the second intermediate tayer 25b under the bottom surface of the intermediate die-

hate 44 which is formed through the lower dielectric sub-

strate 27.

surface 22 portions of the upper dielectric substrate 28 and intermediate dielectric substrate 29, the radiating which forms the top layer pattern for the top layer 21 is strate 28 by thick film or thin film process. On left side pattern 33 is printed by thick film or thin film process. On the first intermediate layer 25s under the bottom surface [0070] The radiating conductor top layer pattern 31 printed on the top surface of the upper dielectric subconductor left side pattern 32 is printed by thick film or thin film process. On right side surface 23 portions of tectric substrate 29, the radiating conductor right side of the upper dielectric substrate 28 (or on the top surface of the intermediate dielectric substrate 29), a shielding conductor top surface pattern 53 which forms the first intermediate pattern is printed by thin film process. On the second intermediate layer 255 under the bottom surface of the intermediate dietectric substrate 29 (or on the top surface of the lower dielectric substrate 27), the layer pattern are printed by thin film process. On a left a shielding conductor bottom surface pattern 56 which the upper diefectric substrate 28 and intermediate diefirst spiral conductor pattern 41 and second spiral conductor pattern 42 which form the second intermediate side surface 22 portion of the tower dielectric substrate 27, the feeding conductor pattern 34 is printed by thick film or thin film process. On the bottom layer 26 under the bottom surface of the lower dielectric substrate 27, thin film process. On front surface 24 portions of the Inermediate dielectric substrate 29 and lower dielectric substrate 27, a shleiding conductor front surface pattern ä 8

[0073] In the structure of this embodiment also, the permittivity values of the upper dielectric substrate 28, lower dielectric substrate 27, and Intermediate dielectric

substrate 29 may be identical or different. However, when they are different, it is preferable to make the per-

53 and the shielding conductor bottom surface pattern

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printed by thick film or thin film process. On rear strate 29 and lower dielectric substrate 27, a shielding conductor rear surface pattern 55 is printed by thick film

se 30 portions of the Intermediate dielectric sub-

tromagnetic coupling between the radiating conductor and the resonant drouts is significantly suppressed, Iment of the FIG. 1 can be realized and the multi-mode aconomy of scale can be achieved. As compared to the (0075) In this embodiment structure, as is the case for the embodiment of FIG. 16, the structure of the embodantenna in which the invention is embodied can be fabricated by mutitlayer substrate fabrication method (mut-Bayer process); consequently, downstaing the mutth mode entenna and cost reduction by manufacturing embodiment of FIG. 16, in this embodiment, the elecwhich yields an effect that design of the resonant circuits

29 are bonded together and the bottom surface of the intermediate dielectric substrate 29 and the top surface

of the lower dielectric substrate 27 are bonded together, and the multilayer structure is completed. For bonding.

for example, the following method is used: forming 28 or the top surface of the substrate 29 and on the botsubstrate 27, pile these substrates, and applying heat

bonding layers on the bottom surface of the substrate tom surface of the substrate 29 or the top surface of the

and pressure to bond them together:

[0071] After these patterns are printed as above, the bottom surface of the upper dielectric substrate 28 and

or thin film process.

the top surface of the intermediate dielectric substrate

24, intermediate layer 25 between layers, and bottom layer 26 which forms the bottom surface, as is the case is described with FIG. 18. FIG. 18 is a diagram showing fabrication method, wherein the antenna structure is [0076] Another embodiment of the present invention a smatt mutti-mode antenna structure in which the invention is embodied in relation to its multilayer substrate made up of the top tayer 21 which forms the top surface, left side surface 22, right side surface 23, front surface

becomes easy.

high frequency range of a GHz band and above, the width of the meandering conductors can be wider than in that the spiral conductors 41 and 42 are replaced with meandering conductors 45, 46. By adoption of the meandering conductors, in an instance where the antenna in which the invention is embodied is applied to a ultrahe width of the spiral conductors and, thus, the resist-[0077] Difference from the embodiment of FIG. 16 lies ance loss of the conductors in this section can be reluced, which yields an effect that the antenne efficiency for the embodiment of FIG. 16. [0072] In the mutiliayer structure, the following electrical joints are formed. The radiating conductor top layer pattern 31, the radiating conductor left alde pattern 32,

tem 32 and the first spiral conductor pattern 41 are joined electrically. The radiating conductor right side pattern 33 and the second spiral conductor pattern 42

and the radiating conductor right side pattern 33 are joined electrically. The radiating conductor left side patand the radiating conductor left side pattern 32 are joint-ed electrically. The first spiral conductor pattern 41 and the shielding conductor bottom surface pattern 56 are electrically joined via the first through hole 43 which is

formed through the lower dielectric substrate 27. The second spiral conductor pattern 42 and the shleiding joined via the second through hote 44 which is formed through the lower dielectric substrate 27. The shielding to the shielding conductor top surface pattern 53 and shielding conductor rear surface pattern 55 is electrically joined to the shielding conductor top surface pattern

conductor bottom surface pattern 56 are electrically

conductor front surface pattern 54 is electrically joined the shielding conductor bottom surface pattern 56. The

are joined electrically. The feeding conductor pattern 34

is described with FIG. 19. FIG. 19 is a diagram showing fabrication method, wherein the antenna structure is 24, first intermediate layer 25a between layers, second Intermediate layer 25b between layers, bottom layer 26 which forms the bottom surface, and rear surface 30, as [0078] Another embodiment of the present invention a smail multi-mode antenna structure in which the invention is embodiad in relation to its mutiliayer substrate made up of the top layer 21 which forms the top surface, teft side surface 22, right side surface 23, front surface is enhanced. \$ 9

[0079] Difference from the embodiment of FIG. 17 fles meandering conductors 45, 46. As compared to the embodiment of FIG. 17, when the antenna in which the inin that the spiral conductors 41 and 42 are replaced with vention is embodied is applied to an uttra-high frequency range of a GHz band and above, this embodiment yields an effect that the antenna efficiency is anhanced, similar to the effect of the embodiment of FIG. 18 in comparison is the case for the embodiment of FIG. 17. to the embodiment of FIG. 16.

Moreover, in this embodiment, it is possible to

mittivity of an upper-layer dielectric substrate lower.

replace the upper dielectric substrate 28, lower dielecinc substrate 27, and intermediate dielectric substrate 29, respectively, with upper, lower, and Intermediate magnetic substrates made of a magnetic substance. In that event, the permeability values of the upper, lower,

and intermediate magnetic substrates may be Identical or different. However, when they are different, it is pref. erable to make the permeability of an upper-layer mag-

10080] Another embodiment of the present Invention is described with FIG. 20. FIG. 20 is a diagram showing a small multi-mode entenna structure in which the in-

vention is embodied in relation to its mutiliayer substrate eft side surface 22, right side surface 23, front surface 24, Intermediate tayer 25 between tayers, and bottom abrication method, wherein the antenna structure is nade up of the top layer 21 which forms the top surface, layer 26 which forms the bottom surface, as is the case for the embodiment of FIG. 16.

to the radiating conductor left side pattern 32, the first where in the feeding conductor 34 and connecting the embodiment, the multi-mode antenna in which the invention is embodied can be fabricated by multilayer [0081] Difference from the embodiment of FIG. 16 lies clined to the first strip conductor 53, in the structure of tial of the RF circuit, the structure of the embodiment of the FIG. 4 can be realized. Therefore, according to this in that the feeding conductor 34 is not electrically joined strip ground conductor 51 is replaced with a strip conductor 53, and the feeding conductor 34 is electrically this embodiment, by setting up the feeding point enysecond strip ground conductor 52 to the ground potenprocess and, consequently, downsizing the multi-mode antenna and cost reduction by manufacturing economy of scale can be achieved.

[0082] Another embodiment of the present invention is described with FIG. 21. FIG. 21 is a diagram showing a smell multi-mode antenna structure in which the Inleft side surface 22, right side surface 23, front surface vention is embodied in relation to its multilayer substrate fabrication method, wherein the entenna structure is 24, intermediate fayer 25 between layers, and bottom layer 26 which forms the bottom surface, as is the case made up of the top layer 21 which forms the top surface, for the embodiment of FIG. 20.

in that the spiral conductors 41 and 42 are replaced with an effect that the antenna efficiency is enhanced, similar to the effect of the embodiment of FIG. 18 in comparison [0083] Difference from the embodiment of FIG. 20 lies meandering conductors 45, 46. As compared to the embodiment of FIG. 20, when the antenna in which the invention is embodied is applied to an uttra-high frequency range of a GHz band and above, this embodiment yields to the embodiment of FIG. 16.

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22B are diagrams showing a structure of an RF module (0084) Another embodiment of the present invention s described with FIGS. 22A and 22B. FIGS. 22A and aquipped with a multi-mode antenna, wherein the invenion is embodied; these diagrams are, respectively, a top On the front surface of an RF substrate 101 view and a bottom view of the RF module.

consisting of a single tayer or multiple layers, a small multi-mode antenna 102 of the present invention and a multi-contact switch 103 are placed on the same

power amplifier (PA) 112a (112b, 112c) are concatenated in order from a transmit signal input terminal 123a (123b, 123c). A receive circuit (Rx) 115a (115b, 115c) and a low noise amplifier (LNA) 114a (114b, 114c) are A transmit circuit (Tx) 113a (113b, 113c) and a

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[0087] A first ground conductor 104 which is formed minal 125a (125b, 125c). A first branch output of the output to the low noise ampilifer (LNA) 114a (114b, 114c) In a plane conductor pattern is formed on the front surface of the RF substrate 101 and a second ground conconcatenated in order from a receive signal output ter power amplifier 112s (112b, 112c) and a second branch are connected to a duplexer (DUP) 111a (111b, 111c). ductor 105 which is formed in a plane conductor pattern is formed on the reverse side.

nais 124 for receivers, receive circuit output terminals switch, and an RF multi-contact switch control terminal [0055] On the circumferences of the RF substrate first ground terminals 107, second ground terminats 120, power source terminats 121 for power amplifiers, power source terminals 122 for transmit circuits transmit signal input terminals 123, power source termi-125, a power source terminal 106 for RF multi-contact 108 are disposed.

[0089] A ground terminsl of the multi-mode antenna common contact of the RF multi-contact switch 103 and Individual contacts of the RF multi-contact switch 103 are connected to common branch inputs of the duplex-102 is electrically connected to the first ground conductor 104 that encloses the multi-mode antenna. A feeding point of the mutti-mode antenna 102 is connected to a ers 111a (111b, 111c).

[0090] A ground terminal of the RF multi-contact switch 103 is electrically connected to the second ground conductor 105 via a through hole 131. Ground terminals of the power amplifiers 112a (112b, 112c) transmit circuits 113a (113b, 113c), low noise ampliffers 114s (114b, 114c), and receive circuits 115s (115b, 115c) are electrically connected to the second ground conductor 105 via through holes 132.

to the first ground conductor 104 and the second ground conductor 105 and the second ground terminals 120 are [0091] The first ground terminals 107 are connected connected to the second ground conductor 105.

122a (122b, 122c) for transmit circuits are connected to piffers are connected to the power source sections of the power emplifiers 112s (112b, 112c) by a suitable wiring conductor pattern and the power source terminals the power source sections of the transmit circuits 113a (113b, 113c) by a suitable wiring conductor pattern. The power source terminals 124a (124b, 124c) for receivers are connected to the power source sections of the recontact switch and the RF multi-contact switch control [0092] The power source terminals 121 for power armceive circults 115a (115b, 115c) and the low noise amplifiers 114a (114b, 114c) by a sultable wiring conductor pattern. The power source terminal 106 for RF multiterminal 108 are, respectively, connected to the power source section and the control signal input section of the RF multi-contact switch 103 by a suitable wiring conduc-

[0093] As for the units, namely, the duplexers 111, power emplifiers 112, transmit circuits 113, low noise

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5 amplifiers 114, and receive circuits 115, and as for the system are assumed to use three carrier frequencies and these units and terminals in sets of three  $(a,\,b,\,c)$ terminals, namely, the power source terminals 121 for source terminals 124 for receivers, and receive circuit vide information transmission services to be handled by power amplifiers, power source terminals 122 for transnit circuits, transmit signal input terminals 123, power output terminals 125, a plurality of these units and terminals as many as the number of carrier frequencies are mounted on the RF substrate 101, wherein the carrier frequencies are used by a wireless system to prohe RF module equipped with the multi-mode antenna of this embodiment. In this embodiment, the wireless

generally required to handle signals with a wide spec-trum of frequencies from LF (low frequency) circuits that control man-machine interfaces to RF circuits that genviding information transfer by wireless communication ess information transmission services to the user, it is [0094] This RF module structure is a variant of the module that applies for a case where the system prouses a FDD (Frequency Division Multiple Access) system. For wireless apparatus capable of providing wiresrate and radiate electromagnetic waves.

0095] Especially, for RF choults, a different form of realization from realizing LF circuits and IF (intermediate frequency) circuits is required, involving as short a wiring length as possible by using a costly substrate manufactured from high-priced substances with low loss properties and the use of a number of shielding layers for reducing electromagnetic interference from wiring patterns on the substrate, etc. in view of loss in terms of material constants, circuit performance deterlorated by stray components, and others. For this reason, a geninal manner is applied in which RF circuits are manuactured in modules and constructed separately from other LF and IF circuits and the RF modules are mounted on a circuit board on which the LF and IF circuits are also mounted.

(0096) In prior art, because an antenna capable of multI-mode operation at a single feeding point has not been found, it was needed to mount a plurality of costly RF modules on a circuit board where LF and IF circuits ere also mounted and this was a major factor of increasing the cost of wiring apparatus equipped with the RF modutes. A plurality of RF modules are scattered across the circuit board and this requires long wiring of RF sigwhich caused a problem in which unwanted radiation of electromagnetic waves emitted by these lines deterional lines and power source lines for power amplifiers. rates the performance of other circuits.

ers into a singe RF module; this yields effects of reducing multimedia wireless apparatus manufacturing costs and improving the apparatus sensitivity. sible to integrate RF circults that process multiple carri-0098] Another embodiment of the present invention [0097] According to this embodiment, it becomes pos-

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101 to supply power for the operation of the RF two-conflact switches 116 and power is supplied from the power source seminals 126 for RF two-contlact switches to the RF two-contlact switches the power source standard switches 116 by a suitable witing is described with FIGS. 23A and 23B. FIGS. 23A and 23B are diagrams showing another structure of an RF module equipped with a multi-mode anterna, wherein the invention is embodied; these diagrams are, respecpower source terminats 126 for RF two-contact switches are attached to the circumferences of the RF substrate and 22B lies in that RF two-contact switches 116 are employed instead of the duplexers 111 and that new tively, a top view and a bottom view of the RF module conductor pattern and a through hole 133. 5

module that applies for a case where the system pro-viding information transfer by wheless communication uses a TDD (Time Division Multiple Access) system. [0100] This RF module structure is a variant of the The effects of this embodiment are the same as those of the embodiment of FIGS, 22A and 22B. 8

the TDD system can be more relaxed than those for the duplexers enabling the FDD system and, therefore, the former can be realized in smaller dimensions. Thus, this [0101] In general, the specifications of filters for use in the circuitry of the RF two-contact switches enabling embodiment also yields effects of downstzing the RF module equipped with the multi-mode antenna, wherein the invention is embodied, and, moreover, downstring the wireless apparatus using the module.

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duplexers should be employed in circuit blocks for the former and the RF two-contact switches in circuit blocks [0102] When the wireless apparatus supports a plurailly of information service systems, some of which are FDD and other of which are TDD, it is self-evident that for the latter from retation to the embodiment of FIGS. 22A and 22B.

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is described with FIGS. 24A and 24B. FIGS. 22A and module equipped with a multi-mode antenna, wherein the invention is embodied; these diagrams are, respec-Difference from the embodiment of FIGS, 22A and 22B lies in that a portion of the second ground conductor 105, corresponding to the region where the multimode anterna 102 is mounted on the RF substrate 101, [0103] Another embodiment of the present Invention 22B are diagrams showing another structure of an RF Ilvely, a top view and a bottom view of the RF module. [0104] \$ ŧ

[0105] The effects of this embodiment are the same as those of the embodiment of FIGS. 22A and 22B. In this embodiment, unless the muttl-mode entenna 102 has one-sided directivity, the multi-mode antenna can radiate electromagnetic waves as well in the direction of the reverse side of the RF substrate 101. Thus, this embodiment yields an effect of enhancing the gain of the multi-mode antenna and, in consequence, an effect of enhancing the sensitivity of the wireless apparatus using the RF module equipped with the multi-mode an 8

enne of this embodiment.

### Industrial Applicability

In an information system that provides a plurality of information transmission services by using carriers with minals such as multi-modemobile phones and personal [0107] As implied above, the present invention is suitable for being applied to multimedia wireless apparatus multiple frequencies, such as, e.g., mobile wireless terhandy phones (PHS), wireless LAN terminals, or comslex terminals having these muttiple functions.

### Clalms

# A multi-mode antenna comprising:

- a first one-port resonant circuit connected to a second one-port resonant circuit connected to the other end of the radialing conductor, and a radiating conductor which radiates electromagnetic waves with a plurality of frequencles, a single feeding point which is common for the plurally of frequencies and connected to the one end of the radiating conductor,
  - Irst one-port resonant circult.
- wherein said first one-port resonant circuit is one-port resonant circuit is connected between the connected between one end of sald radiating conductor and a ground potential point, said second other and of said radiating conductor and the ground potential point, and said feeding point is a connection point at which the first one-port resonant circuit and the one end of the radiation conductor The multi-mode entenne according to claim 1, are connected.
- connocted botween one end of said radiating conductor and said feeding point, and said second one-port resonant circuit is connected between the other wherein sald first one-port resonant circuit is end of said radiating conductor and the ground po-The multi-mode antenna according to claim 1,

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one end of said radiating conductor and said feed-ing point, and said second one-port resonant droult is connected between the other end of said radiatcomprising a third one-port resonant circuit ther comprising a third one-port resonant circuit connected between one end of said radiating con-The multi-mode antenna according to claim 1, furductor and the ground potential point, wherein sald first one-port resonant circult is connected between ing conductor and the ground potential point.

wherein an imaginary part of admittance or ating conductor toward the radiating conductor has etive signs with frequency increase in said plurality Impedance in view from said one end of said radia value which alternates between positive and neg-The multi-mode antenna according to claim 1, of frequencies.

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wherein said radiating conductor is a single The multi-mode antenna according to claim 1, continuous body including ground potential.

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wherein said radiating conductor is spatially divided into parts which are electrically connected The multi-mode antenna according to claim 1, by a one-port resonant circuit.

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wherein the sum of the number of poles and the number of zeros in an equivalent circuit representation of the first one-port resonant circuit connected to sald one end of sald radiating conductor is equal to the number of said plurality of frequen The multi-mode antenna according to claim 1, **~**;

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- The multi-mode antenna according to claim 4.
- said third one-port resonant circuit connected to said one end of said radialing conductor is equal to wherein the sum of the number of poles and tations of said first one-port resonant circuit and the number of zeros in equivalent circuit representhe number of said plurality of frequencies.

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# A multi-mode entenna comprising:

a first one-port resonant circuit connected to a radialing conductor which radiates electromagnetic waves with a plurality of frequencies. a second one-port resonant circuit connected one end of the radiating conductor,

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a single feeding point which is common for the plurality of frequencies and connected to the a multilayer structure of a laminate of a plurality of substrates comprising top, intermediate and to the other end of the radiating conductor, first one-port resonant circuit, and octom layers,

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wherein a part of the radiating conductor is formed on the top layer, the first one-port resonant circuit and the second one-port resonant circuit are formed on the intermediate layer, the feeding point is formed on a side surface of the multilayer structure, and a ground conductor having ground poter-

said second one-port resonant circuit is formed on wherein another intermediate layer is formed netic coupling between said radiating conductor and said first one-port resonant circuit as well as between said top layer and said intermediate layer and a shielding conductor to suppress electromag-11. The multi-mode antenna according to claim 10, tial is formed on the bottom tayer.

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wherein said shielding conductor is electrical-The multi-mode antenna according to claim 11, ly connected to the ground potential.

the another Intermediate layer.

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- 2 The multi-mode antenna according to claim 10, wherein said first one-port resonant circuit and said second one-port resonant circuit are formed as spiral conductors.
- and said second one-port resonant circuit are wherein said first one-port resonant circuit 14. The multi-mode antenna according to claim 10, formed as meandering conductors.
- 8 comprising dielectric substances and magnetic The multi-mode antenna according to claim 10, wherein said plurality of substrates are made of a radio frequency material selected from a group substances.
- \$ 2 wherein, when said plurality of insulating substrates are made of a dielectric substance, the plueach other and the permittivity of an upper-layer rality of substrates have different permittivity values substrate is lower than that of a lower-layer sub-The multi-mode antenna according to claim 15,
- wherein, when said plurality of insutating substrates are made of a magnetic substance, the plurailty of substrates have different permeability values each other and the permeability of an upperlayer substrate is lower than that of a lower-layer The multi-mode antenna according to claim 15,

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comprising a radiating conductor which radiates electromagnetic waves with a plurality of frequencles, a first one-port resonant circuit connected to one end of the radiating conductor, a second one-A method for fabricating a multi-mode antenna

port resonant circuit connected to the other end of which is common for the plurality of frequencies and the radiating conductor, and a single feeding point connected to the first one-port resonant circuit, the method comprising the steps of: forming a part of the radiating conductor on a top layer on the top surface of an upper substrate by film forming process;

forming the first one-port resonant circuit and termediate layer under the bottom surface of tial on a bottom layer under the bottom surface forming a conductor including the feeding point on a side surface of the lower substrate by film the second one-port resonant circuit on an informing a ground conductor with ground potenof a lower substrate by film forming process; the upper substrate by film forming process;

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bonding the bottom surface of the upper substrate and the top surface of the lower substrate to form a multilayer structure. forming process; and

## 19. A RF module comprising:

tacts as the number of a plurafity of frequenan RF multi-contact switch with as many concles, the RF mutil-contact switch being connected to a single feeding point of the muftia multi-mode antenna as recited in claim 1, mode antenna,

a plurality of circuit blocks respectively connected to the contacts of the RF multi-contact

a single-layer or multilayer RF substrate,

if-contact switch, and the plurality of circuit blocks wherein the multi-mode antenna, the RF mulare mounted on the RF substrate,

connected to the power ampliffer, a low noise am-pilifer connected to the other terminal of the duplexwherein each of the plurality of circuit blocks comprises a duplexer, a power amplifier connected to one terminal of the duplexer, a transmit circuit er, and a receive circult connected to the low noise wherein a plurality of common branch outputs of the duplexers corresponding to the plurality of dr-cult blocks are connected via the RF multi-contact switch to the single feeding point of the antenna.

## 20. A RF module comprising:

an RF multi-contact switch with as many contacts as the number of a phurality of frequencies, the RF multi-contact switch being connected to a single feeding point of the multia multi-mode antenna as recited in claim 1,

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mode antenna, a plurality of circuit blocks respectively connected to the contacts of the RF multi-contact switch, and

a single-layer or multilayer RF substrate,

wherein the multi-mode antenne, the RF multi-contact switch, and the plurally of circuit blocks are mounted on the RF substate, wherein each of the plurally of circuit blocks comprises an RF two-contact switch, a power am-

wherein each of the plurality of circuit blocks comprises an RF two-contact switch, a power amplifier connected to one sterminal of the RF two-conert starts switch, a transmit circuit connected to the power amplifier, a low notes amplifier connected to the other terminal of the RF two-confact switch, and a recave circuit connected to the low notes amplifier,

wherein a plurality of common branch outputs of the RF two-contact switches corresponding to the plurality of circuit blocks are connected via the RF 20 mult-contact switch to the single feeding point of the anianne.

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F/G. 1

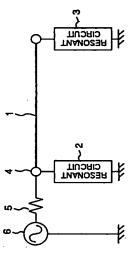
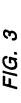
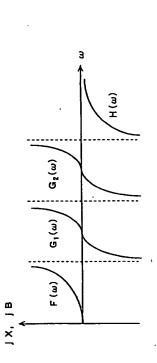
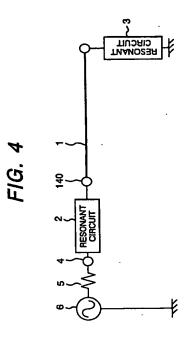


FIG. 2

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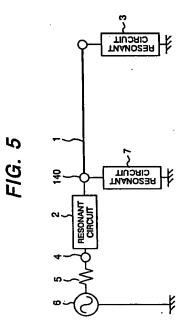
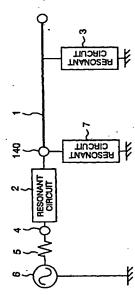
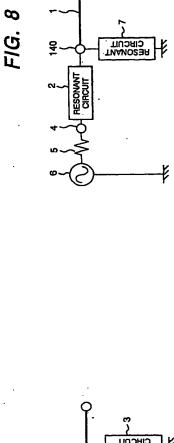
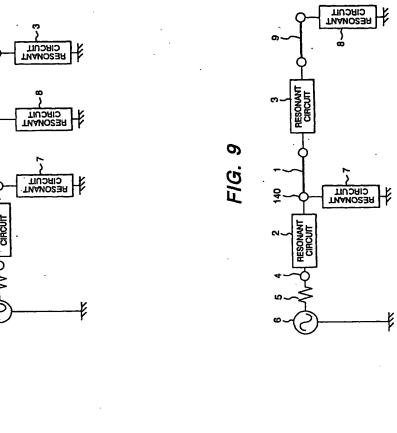


FIG. 6







B 5 4 2 140 RESONANT CIRCUIT CIRCUIT CIRCUIT CIRCUIT CIRCUIT 33

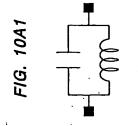


FIG. 10B1

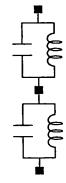


FIG. 10B2

FIG. 10A2

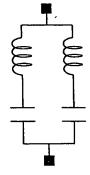


FIG. 11A

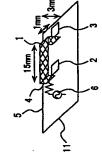
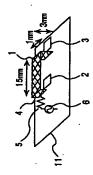


FIG. 11B

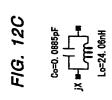






## FIG. 12B







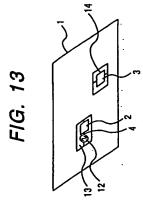
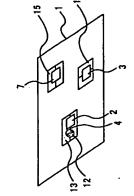
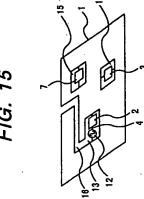
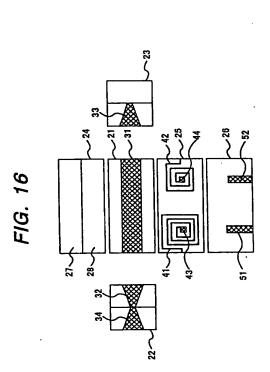


FIG. 14



F/G. 15





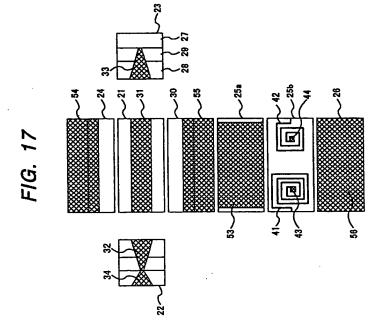
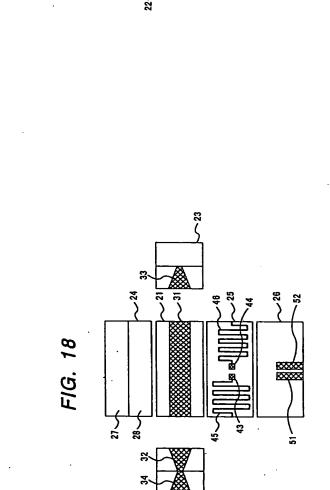
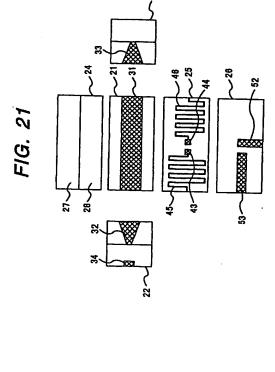


FIG. 19



F/G. 20



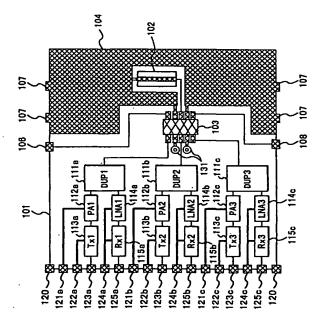
32

5

en

FIG. 22A

FIG. 22B



123a <u>122a 123a</u> 122a <u>122a</u> 121a <u>12</u>

122b

125a

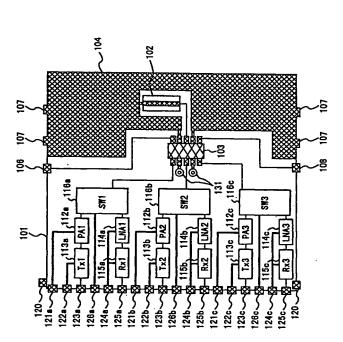
123b

108 107 107

 1216

125b

FIG. 23A



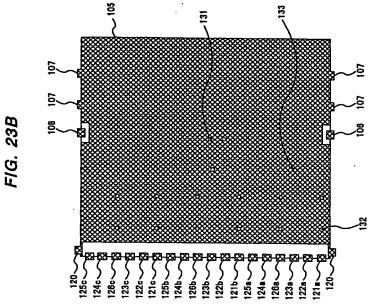


FIG. 24A

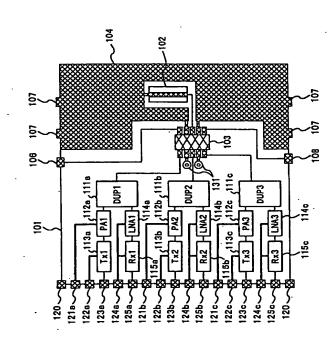
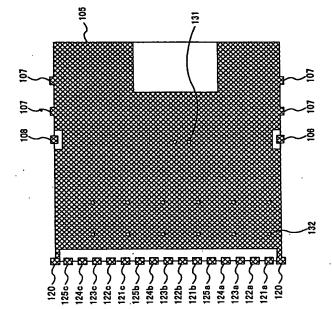


FIG. 24B



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International Search Report	C. CLASSIFICATION OF SUBJECT WANTER INt.Cl. R0105/01, 9/30 texteding to introvulous Peers Clessification (IPC) or to both mational chamilication and IPC	FIBLUS STAKCHED from decrementals searched (chastication primes followed by chestilization symbols) Int. Cl. 10101/00-11/20, 13/08	commentation searched other than minimum documentation to the extract that such documents are included in the fields searched Jitanyo Shihman Koho 1992-1996 Turcoku Jitanyo Shihman Koho 1994-2003 Kokal Jitanyo Shihman Koho 1971-2003 Jitanyo Shihman Turcoku Koho 1996-2003	Sectorale data bun cours had during the internsticeal search (soms of data base and, where practicable, search forms used)	DOCUMENTS CONSIDERED TO BE RELEVANT	EP 1202393 AZ (Mitaubishi Materiale Corp.), 02 May, 2002 (02.05.02), Phil text, all drawings 4 US 2002/0118143 Al 6 UP 2002-204121 A	JP 2002-300081 h (Kyocera Cos 11 October, 2002 (11.10.02), Full text, all drawings (Family: none)	JP 9-82232 A (Hitachi, Ltd.), 28 March, 1997 (28.03.97), Full text; all drawings [family: none)	1.	Special catagories of dead document: considerate China process of the set which is not considerate to the gatchest reference the international III- guide document in chination for other the international III-guide document which they prove doors to sprivity chination for which is document which they applicate due to excellent elistics or when special execution for specification due to excellent elistics or other special execution for specifical control of the special concesses published per each discission, was, exhibition or other research.		ane and mailing address of the ISA Japanese Patent Office
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